

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Non-Fee Amendment Commissioner for Patents Washington, D.C. 20231

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(Date of Deposit)

Response Som ainles

Harold C. Moore

Name of person mailing document or fee

Signature

April 7, 2003

Date of Signature

Re:

Application of:

Newell E. Chiesl

Serial No.:

09/960,441

Filed:

September 21, 2001

Confirmation No.:

5776

For:

Arrangement for Measuring Pressure on a Semiconductor Wafer and an Associated

Method for Fabricating a Semiconductor

Wafer

Group Art Unit:

2812

Examiner:

Viktor Simkovic

Our Docket:

1003-0610 (01-384)

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Sir:

In response to the Notice of Non-Compliant Amendment dated March 5, 2003 for the above-identified patent application, please amend the application as follows: